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Transmission electron microscopy of Indium Gallium Nitride nanorods grown by molecular beam epitaxy

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This paper demonstrates the growth of InGaN nanorods and lateral growth over nanorod arrays using molecular beam epitaxy. It is shown that nitrogen rich growth conditions result in a nanorod array and that, by changing to metal rich conditions, lateral growth may be enhanced to coalesce the nanorods into a continuous overgrown film. Energy dispersive x-ray spectroscopy has been used to demonstrate that the nanorods

display a core-shell structure with In-rich cores and In-poor edges. Transmission Electron Microscopy has shown that the nanorods are free of dislocations. However when lateral growth occurs basal plane stacking faults are generated. It is shown that this stacking fault generation leads to a change in structure from hexagonal to cubic. When coalescence has occurred large angle grain boundaries are present.

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1 Introduction Indium Gallium Nitride ($\text{In}_x\text{Ga}_{1-x}\text{N}$) has a direct band gap of 0.7eV ($x=1$) to 3.4eV ($x=0$). This spans the visible spectrum and makes InGaN a viable candidate for optoelectronic devices such as LEDs, lasers and photovoltaics [1, 2]. Growth of InGaN may be achieved using various growth techniques such as molecular beam epitaxy (MBE) [3, 4], pulsed laser deposition [5] and metal-organic chemical vapour deposition [2, 6, 7]. However due to a lack of adequately lattice matched substrates InGaN films generally have high threading dislocations.

There are also issues associated with indium incorporation during growth, leading to spatial variations in In content, especially in In rich films [8]. Work by Kehagias et al [9] has used EDX mapping to show that InGaN nanorods grown on (111)-Si substrates have increasing In composition along the length of nanorods which is due to high In desorption rates at temperatures of 450°C. In segregation has also been reported in quantum well and quantum dot structures [4] and in other alloy systems such as InGaAs [10].

InGaN usually has the hexagonal wurtzite form which has a stacking sequence ..ABABAB.. but may also exist in the cubic zinc-blende phase which has the ..ABCABC..

stacking sequence. The wurtzite form is polar in the c -direction (0002), which creates spontaneous electric piezoelectric fields [11] which may act to separate electron hole pairs which is ideal for a photovoltaic device. The zinc-blende structure is not polar [12, 13] and so lacks the piezoelectric field, much like non-polar orientations of wurtzite material which make these favourable to LED and Laser devices.

Previous work with GaN on sapphire [14] has shown that by controlling the N:Ga ratio to N-rich conditions, growth of GaN nanorods with little to no threading dislocations in the nanorods may be achieved. Furthermore by subsequently changing the growth conditions to Ga-rich a GaN film may be grown over the nanorod array which had a low dislocation density, $\approx 10^8 \text{cm}^{-2}$.

2 Method Growth of the samples presented in this paper was performed at Nottingham University by MBE. Samples of InGaN have been directly grown on Si in a Varian ModGen II system at growth temperatures of 400°C to 500°C. Nitrogen-rich conditions were used to promote vertical growth whilst metal-rich conditions were used for lateral growth.

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All cross section samples were prepared for TEM by mechanically polishing to 100µm and ion thinning using a Gatan PIPS Ar ion thinner. Samples were thinned at 5keV until perforation, then at 3keV to remove surface damage. Plan view TEM samples have been prepared using a FEI DualBeam FIB/SEM which uses Ga ions accelerated at 15kV for the initial sectioning and a lower energy 3kV beam to reduce the damage caused by the Ga ion beam. To make the plan view section the sample was first encased in epoxy resin, which provides support for the nanorods during and after milling. The specimen was then mounted with the InGaN/Si interface normal to the focused gallium ion beam direction and a lamella cut out.

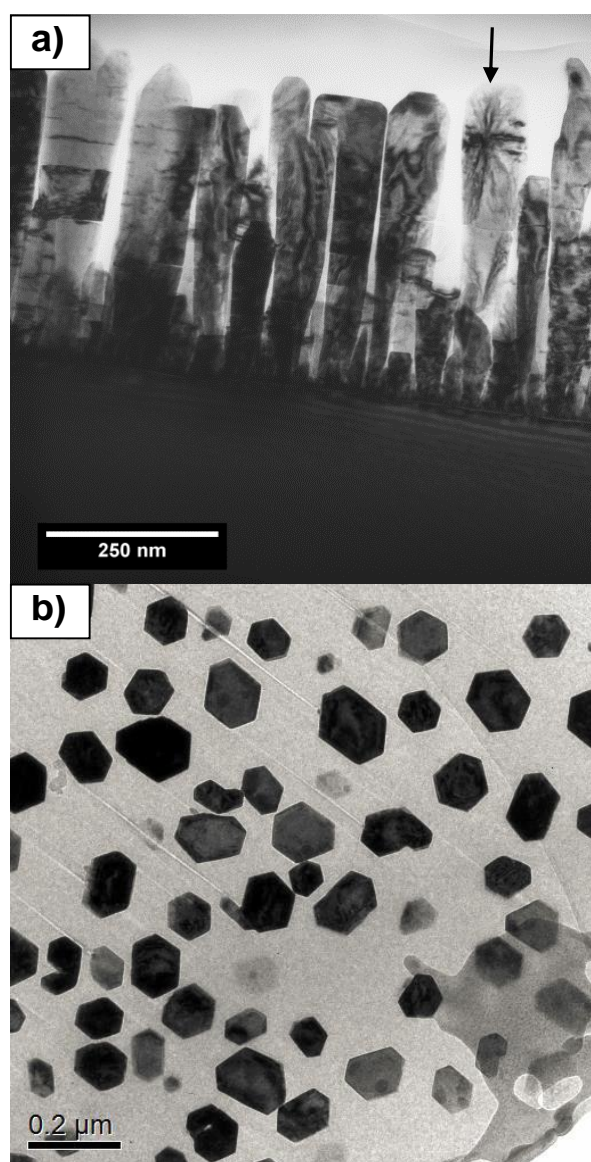


Figure 1 TEM of an N-rich growth resulting in InGaN nanorods shown in a) mechanically polished cross-section with bend contours along the c-direction (arrowed) and b) plan-view prepared by FIB milling.

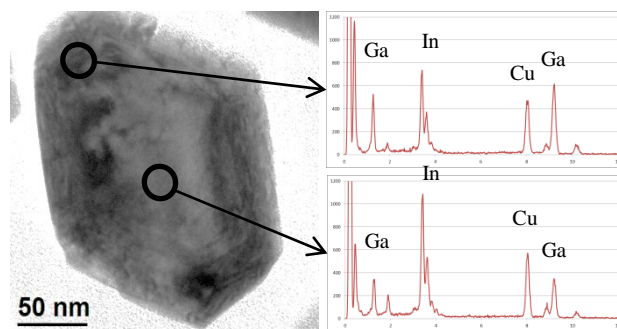


Figure 2 EDX spectra taken from nanorod in plan view. The spectra are from the regions indicated and show a significant increase of In at the centre of the nanorod when compared with the edge.

TEM was performed on a Philips EM430 operated at 200kV. Energy dispersive X-ray spectroscopy was performed on a JEOL 2010 operated at 160kV equipped with an Oxford Instruments EDX spectrometer which was used to characterise the composition of the nanorods by taking point spectra with a spot with a diameter of 20nm.

3 Results and Interpretation Figure 1 shows TEM of InGaN structures grown on (111)-silicon in N-rich conditions at a temperature of 400°C. This promotes vertical growth and suppresses lateral growth. These nanorods are ~500nm long and 100nm wide, are faceted with the c-axis perpendicular to the substrate and are free of threading dislocations. Arrowed in Figure 1(a) is a nanorod orientated close to the $[11\bar{2}0]$ zone axis, which shows contours along the length of the nanorod indicating that the nanorod is bending around the c-axis. These contours are not visible in all nanorods as there is significant rotation about the c-axis as can be seen in Figure 1(b). This demonstrates that nanorods have not grown epitaxially.

Plan view of the nanorods shown in Figure 1(b) demonstrates the faceted nature of the nanorods. Spot EDX has been taken on this sample (shown in Figure 2) with the electron beam at the edges of the structures and at the centres and has shown a significant increase of In composition towards the centre of the nanorods which explains the bending around the c-axis (seen in Figure 1(a)) due to the larger lattice constant of the indium rich core.

Figure 3 shows a sample grown in metal-rich conditions and at a higher temperature of 500°C. In these conditions the lateral growth is enhanced and a film has grown over the nanorod array. The grain size of the overgrown film is larger than 500nm which spans multiple nanorods implying that as neighbouring nanorods coalesce there is a degree of recrystallisation. There are large angle grain boundaries where large misorientated grains

coalesce. When coalescence is attempted at a lower growth temperature (400°C) as shown in Figure 4, stacking faults are observed where the growth conditions have been changed. There is also a change in structure from hexagonal in the nanorods to cubic during lateral growth which can be seen in the selected area diffraction (SAD) pattern of Figure 4(c) which shows the [110] zone axis diffraction pattern for the cubic zinc-blende phase. After a second stacking fault, inclined 70° to the basal plane, the structure reverts to the wurtzite structure as shown by the [11 $\bar{2}$ 0] zone axis SAD pattern of Figure 4(d). EDX has shown that the composition of the cubic area is significantly more In-rich when compared to the hexagonal areas.

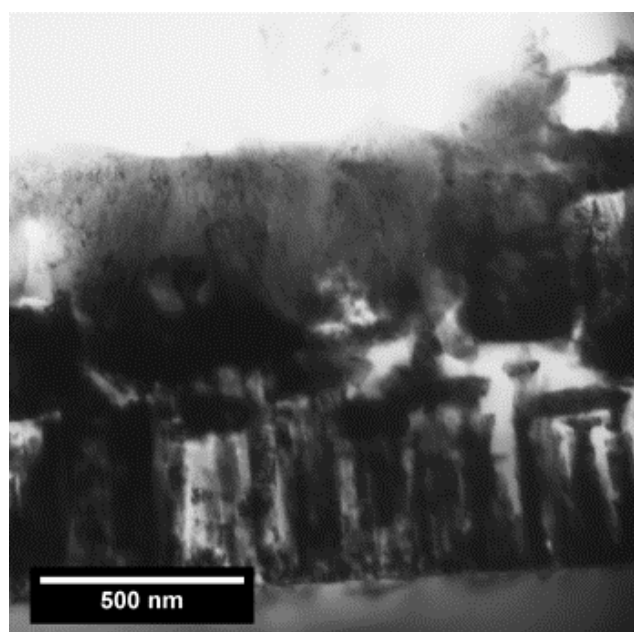


Figure 3 A N-rich growth resulting in nanorods at the base, followed by a metal rich growth which resulted in coalescence.

4 Discussion These results demonstrate that by controlling the growth conditions defect free nanorods may be directly grown on silicon. It is possible to achieve coalescence of these structures using metal-rich conditions resulting in grains which span multiple nanorods, typically wider than 1 μm . It may be seen when observing the nanorod array in plan-view (Figure 1(b)) that the nanorods are rotated with respect to each other around the c-axis. This leads to the large angle grain boundaries observed where coalescence occurs.

EDX has been used to show there are large variations in composition radially in the nanorods. The change in composition leads to mismatch strains with the In-poor shell being under tension. This can explain the bending observed occasionally along the nanorod axis as partially thinned nanorods relax (Figure 1(a)). The radial variation in composition may be explained by considering desorption and migration of In. At growth temperatures of

400-500°C, any Ga deposited should be essentially immobile and not desorbed. The core-shell structure may be explained by considering In desorption at the growth temperature, this acts to shield nanorods from the In source during growth resulting in an In-poor surface.

A change to metal-rich growth conditions has the effect of increasing the In composition rapidly. This causes an in-plane stress which explains the large number of stacking faults in this transition region as stacking faults can relieve strain in the basal plane. The change of structure from hexagonal in the nanorods to cubic in the lateral growth might be caused by the local change in the stacking sequence from hexagonal to cubic associated with a stacking fault. In cubic material, a stacking fault is associated with a local transition from cubic to hexagonal stacking, and it may be that this accounts for the reverse transition from cubic to hexagonal material after the stress caused by the change in composition has been accommodated.

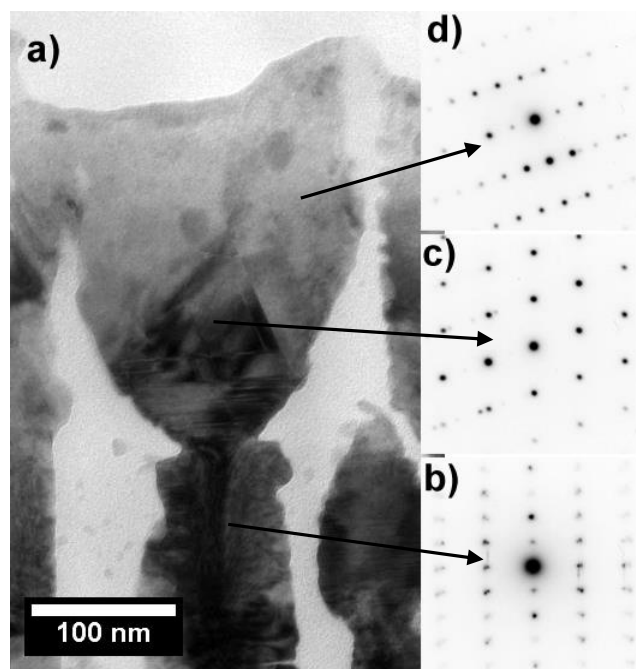


Figure 4 a) Cross section TEM of a nanorod with subsequent metal-rich growth with a large number of stacking faults at the interface of the two growth conditions. SAD from the regions arrowed show a change of structure from hexagonal to cubic and back to hexagonal in b), c) and d) respectively. b) and d) are hexagonal [11 $\bar{2}$ 0] zone axis diffraction patterns and c) is a cubic [110] diffraction pattern. The central nanorod is in the [11 $\bar{2}$ 0] orientation.

5 Summary It has been demonstrated that InGaN nanorods may be grown by MBE with N-rich conditions, which is in agreement with previous work on GaN. There is a higher indium content in the centre of the nanorods which has been shown by EDX. It has also been demonstrated that it is possible to coalesce nanorods using

metal-rich conditions which tends to form a continuous layer. For low growth temperatures in metal-rich conditions, stacking faults occurred which had the effect of changing the structure from hexagonal to cubic, this was reversible, resulting in inclined hexagonal growths.

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